

## **Product Change Notification - CYER-11SNTE468**

Date: 22 Sep 2011

Product Category: Analog (Thermal, Power Management & Safety)

Device Family:

Notification subject: CCB 1070: Qualification of 3L SOT-89 with full Ag platting on the paddle at HANA assembly site.

Notification text:

PCN Status: Final notification

Microchip Parts Affected:

See attachments of affected catalog part numbers (CPN) labeled as...

PCN\_CYER-11SNTE468\_Affected\_CPN.xls PCN\_CYER-11SNTE468\_Affected\_CPN.pdf

Description of Change:

Qualification of 3L SOT-89 with full Ag platting on the paddle at HANA assembly site.

Pre Change:

Ag ring plating on paddle

Post Change:

Full Ag plating on paddle

Impacts to Data Sheet:

None

Reason for Change:

To improve on time delivery performance

Change Implementation Status:

In Progress

Estimated First Ship Date:

September 30, 2011 (date code: 1140)

NOTE: Please be advised that during the transition period customers may receive pre and post change parts, due to existing inventory of the pre changed parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

July 14, 2011: Issued initial notification.

July 27, 2011: Revised initial notification to clarify that only the paddle will have Ag platting not the entire

lead-frame.

September 22, 2011: Issued final notification and added the qualification report.

PCN\_CYER-11SNTE468\_Affected\_CPN.pdf PCN\_CYER-11SNTE468\_Affected\_CPN.xls Attachment(s):

PCN CYER-11SNTE468 Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

## **Terms and Conditions:**

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CYER-11SNTE468 - 0	CCB 1070: Qualification of 3L SOT	7-89 with full Ag platting on the	paddle at HANA assembly site.
Parts Affected			
MCP111			
MCP112			
MCP1700			
MCP1702			
MCP1703			
11011703			

Date: Friday, September 23, 2011